

NCE70H12

NCE N-Channel Enhancement Mode Power MOSFET



The NCE70H12 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

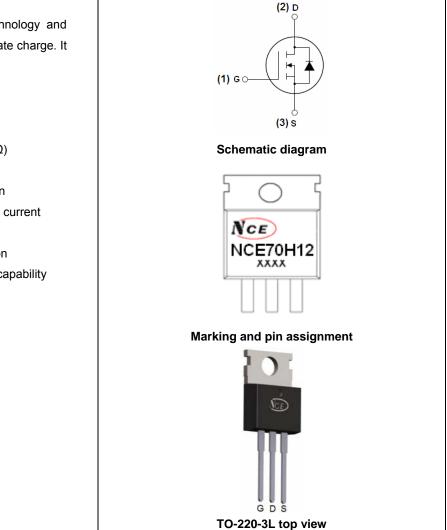
- $V_{DS} = 70V, I_D = 120A$ $R_{DS(ON)} < 6.0m\Omega @ V_{GS} = 10V$ (Typ:4.5m Ω)
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

- Automotive applications
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE70H12	NCE70H12	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25[°]C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	70	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι _D	120	А
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	85	Α
Pulsed Drain Current	I _{DM}	420	А
Maximum Power Dissipation	PD	200	W
Derating factor		1.33	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	800	mJ



Pb Free Product

NCE70H12

Operating Junction and Storage Temperature Range	I J, I _{STG}	-55 lo 175	C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{eJC}	0.75	°C/W
			1

Electrical Characteristics (T_c=25°C unless otherwise noted)

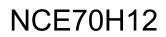
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·		•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	70	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =70V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·		•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A	-	4.5	6.0	mΩ
Forward Transconductance	g fs	V _{DS} =10V,I _D =20A	20	-	-	S
Dynamic Characteristics (Note4)	·		•			
Input Capacitance	C _{lss}		-	4900	-	PF
Output Capacitance	Coss	V _{DS} =25V,V _{GS} =0V,	-	410	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	315	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	20	-	nS
Turn-on Rise Time	tr	VDD=35V,ID=2A,RL=15Ω,	-	19	-	nS
Turn-Off Delay Time	t _{d(off)}	RG=2.5Ω,VGS=10V	-	70	-	nS
Turn-Off Fall Time	t _f		-	30	-	nS
Total Gate Charge	Qg		-	125	-	nC
Gate-Source Charge	Q _{gs}	ID=30A,VDD=35V,VGS=10V	-	24	-	nC
Gate-Drain Charge	Q _{gd}		-	49	-	nC
Drain-Source Diode Characteristics	·		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-	-	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	110	А
Reverse Recovery Time	t _{rr}	Tj=25℃,IF=75A,	-	37		nS
Reverse Recovery Charge	Qrr	di/dt=100A/uS ^(Note3)	-	58		nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligi	ble (turr	i-on is do	minated by	(LS+LD)

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^\circ \!\! \mathbb{C}, V_{DD} \!\! = \!\! 35V, V_G \!\! = \!\! 10V, L \!\! = \!\! 0.5mH, Rg \!\! = \!\! 25\Omega$

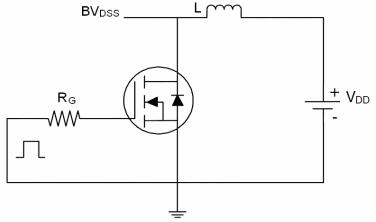




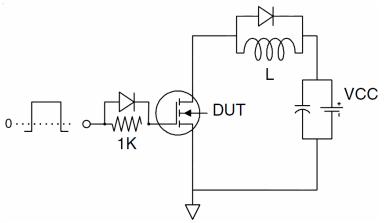


Test circuit

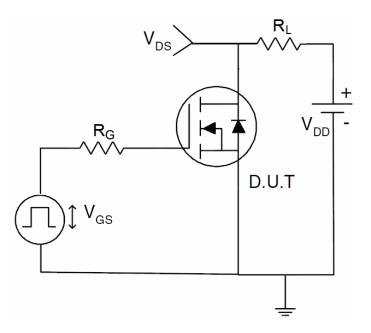
1) E_{AS} test Circuit



2) Gate charge test Circuit



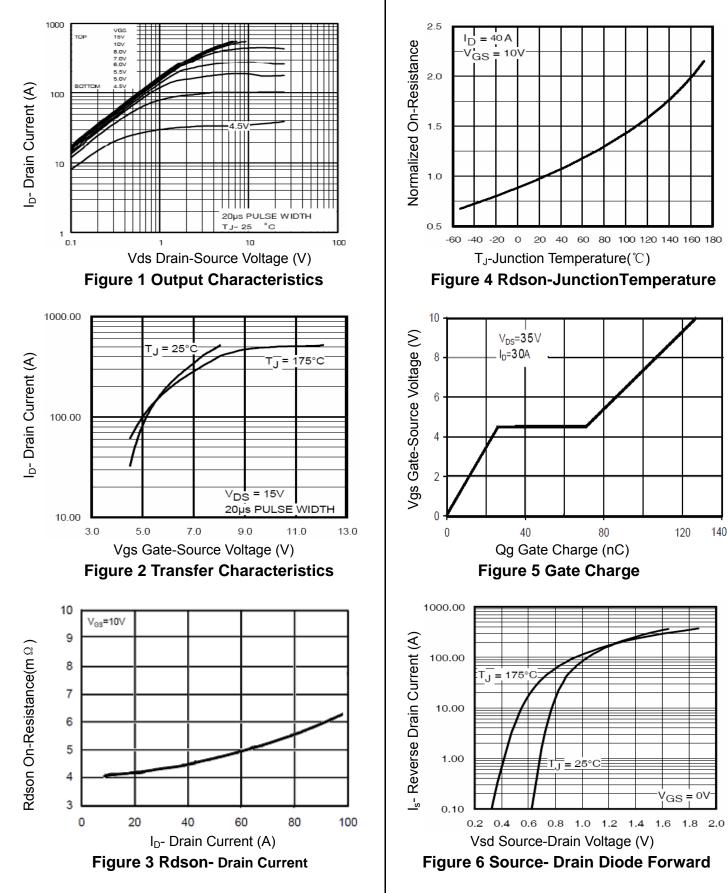
3) Switch Time Test Circuit





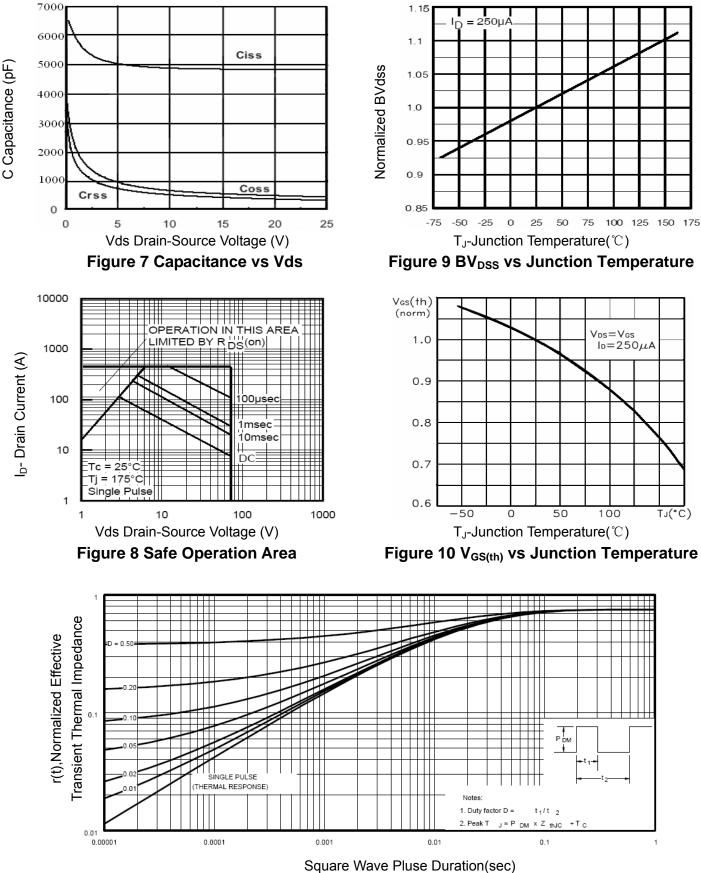


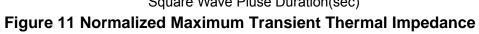
Typical Electrical and Thermal Characteristics (Curves)









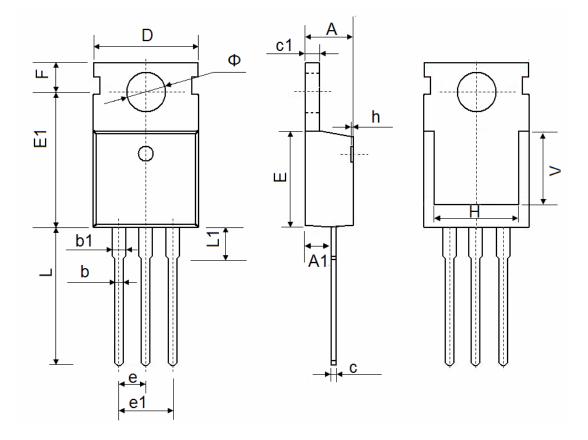








TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295	REF.	
Ф	3.400	3.800	0.134	0.150	







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